



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Wilhelm STEIN et al.

Serial No.:

10/789,199

Filed: February 26, 2004

For:

Electrical Contact

for Optoelectronic

Semiconductor Chip

and Method for its

Production

Examiner: LOUIE, Wai Sing

Group Art: 2814

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AMENDMENT AFTER FINAL REJECTION

SIR:

In response to the Final Office Action dated April 6, 2006, please amend the aboveidentified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 7 of this paper.